Stratix[®] 10: 14nm FPGA Delivering 1GHz

Mike Hutton Product Architect, Altera IC Design

HotChips 2015



Acknowledgements

The Stratix 10 Architecture and Definition Teams

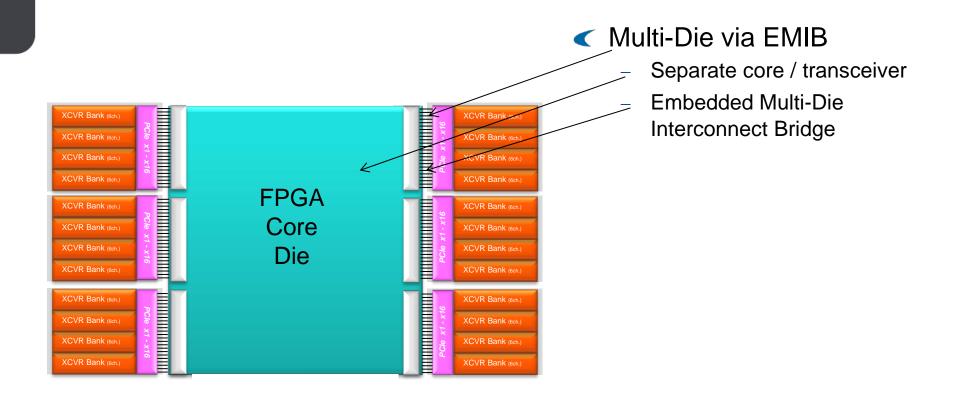
- Herman Schmit, Dana How, Gordon Chiu, Carl Ebeling, Bruce Pedersen, Andy Lee, Martin Langhammer, Ben Gamsa
- Dave Lewis, Valavan Manohararajah, David Galloway, Jeff Chromczak, Tim Vanderhoek, Ian Milton
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- KS Foo, Chee Hak Teh, Lai Guan Tang
- Bernhard Friebe, Eleena Ong, Jordon Inkeles, Allan Davidson, Lux Joshi, Martin Won



Stratix 10 Architectural Big Rocks

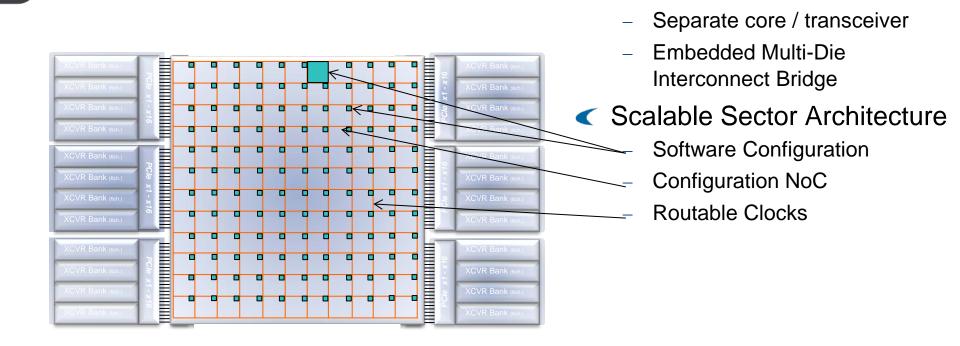
- < 2X the achievable performance of Stratix V
- At up to 70% lower power
- Heterogeneous 3D System In Package (SiP) integration
- Adoption of Intel 14nm tri-Gate process
- Hierarchical configuration and security

Stratix 10 Innovations: 2.5D





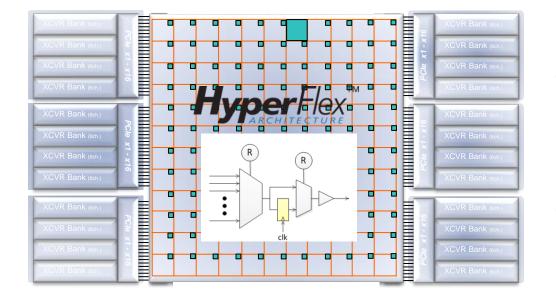
Stratix 10 Innovations: Configuration & Clocking



Multi-Die via EMIB



Stratix 10 Innovations: HyperFlex



< Multi-Die via EMIB

- Separate core / transceiver
- Embedded Multi-Die Interconnect Bridge

Scalable Sector Architecture

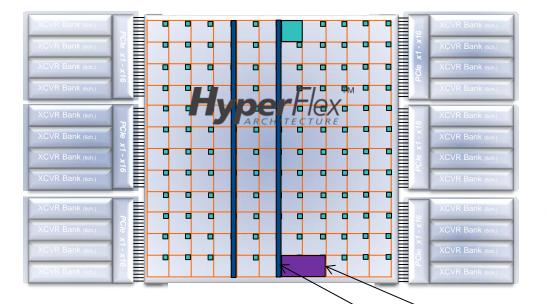
- Software Configuration
- Configuration NoC
- Routable Clocks

Core Performance

- HyperFlex Fabric, Tri-Gate
- 1GHz M20K and DSP MAC
- 750 MHz Floating Point



Stratix 10 Innovations: SoC & Memory



< Multi-Die via EMIB

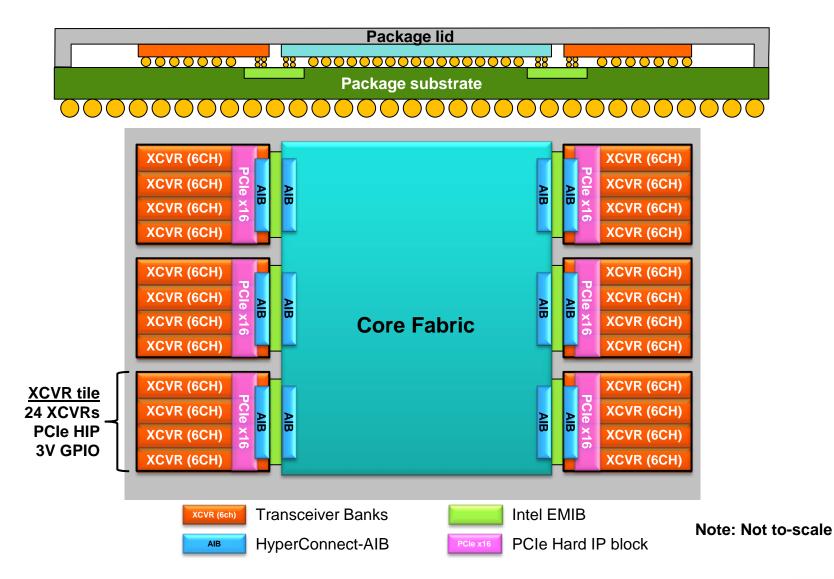
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< SoC

- 1.5GHz Performance ARM[®] Cortex A53
- DDR I/O Banks with Hard Memory Controller

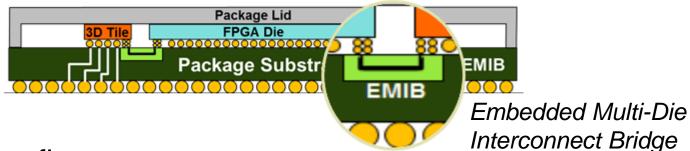


System-in-Package Construction





System-in-Package EMIB Technology



< Many benefits

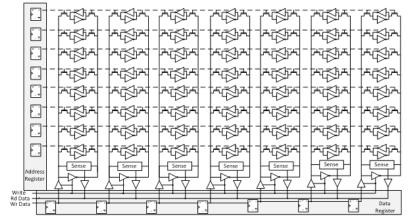
- Reduced complexity vs. full interposer, and no reticle limit
- De-Couple analog (transceiver) development from digital FPGA fabric
- Transceiver reliability & yield enhancement
 - Con't need rectangular "die"
 - Matching transceiver speed-grades
- Tick mixed with tock for added derivatives
 - E.g. 56G PAM4 transceiver tile
 - E.g. new hardened I/O interface IP
 - E.g. SiP Memory or ASIC tiles





Sectors and Configuration Sub-System

- Config-System manages CRAM
- Historically just a shift register
 - AR/DR to Configuration RAM Array
 - FSM controlled



Modern configuration adds significant system functionality

- Encryption, decryption, bitstream compression, redundancy
- Security: authentication, side-Channel, firewall, PUF
- SEU, scrubbing and partial-configuration management
- Debug
- Our solution: move it to software
 - More robust, upgradable, and risk-averse



Stratix 10 Configuration Sub-system Overview

Secure Device Manager (SDM)

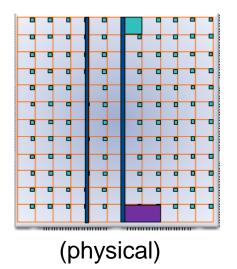
- Config and Re-Config, compression
- Security: authentication, encryption, PUF
- Maintenance (power, T/V, SEU, debug)

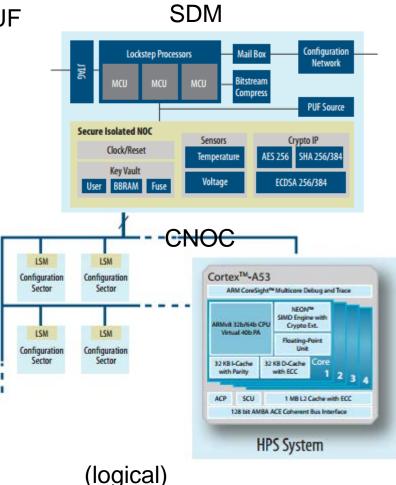
Local Sector Manager (LSM)

Sector configuration manager

Config Network-on-Chip (CNoC)

SDM/LSM Communication



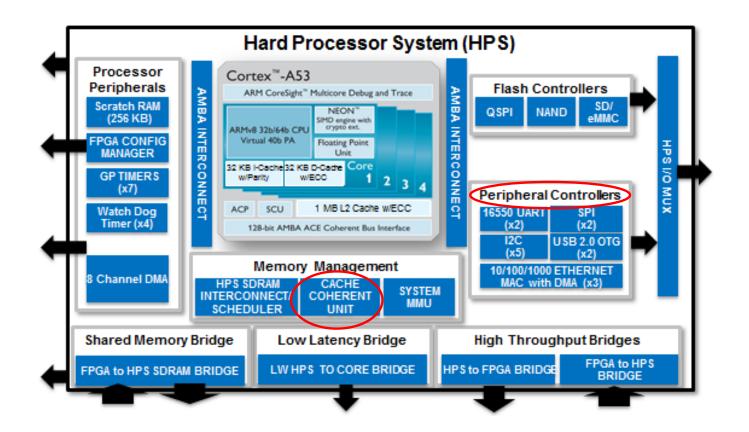




SoC Application Processor

✓ 1.5 GHz Quad-Core ARM[®] Cortex[™] A53

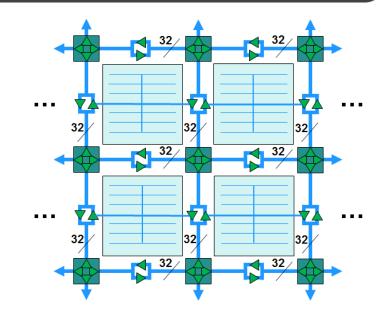
- CCU: Cache-coherency between FPGA accelerators and processors
- Integrated with configuration subsystem (SDM) sharing peripherals

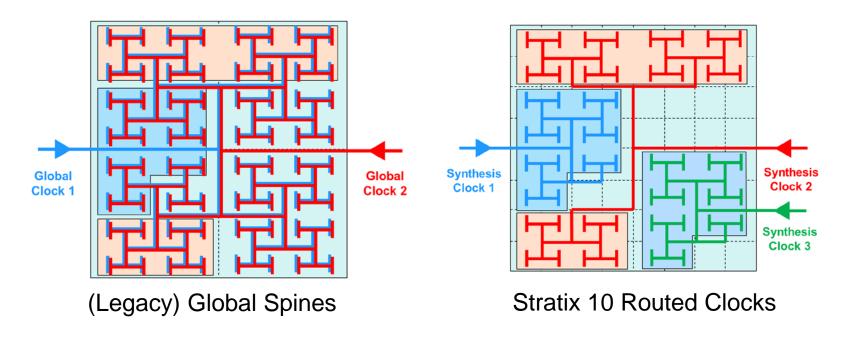




Routable Clocking

- SW-routed clocks in sector "seams"
- More efficient use of globals
- Active skew management



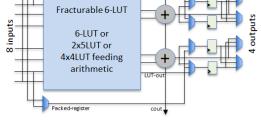




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Core Fabric Building Blocks



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Packed-register

Adaptive Logic Module

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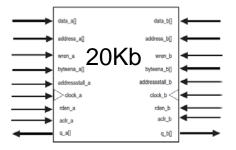
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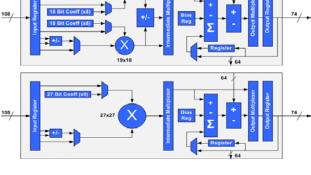
1GHz RAM Data Forwarding

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1GHz DSP MAC 10 TFLOPs IEEE 754



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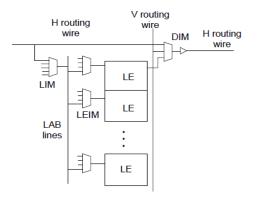
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LIM/LEIM/DIM fabric



Fabric Performance and Power

Performance:

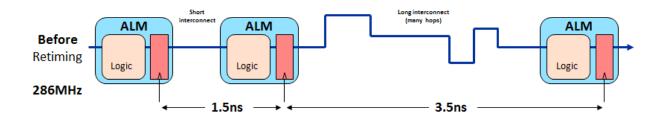
- A complete "re-think" on the philosophy of FPGA Fabric Architecture
- Registers are not just logic resources, they are routing resources
- Goal is to enable seamless movement and addition (pipelining) of registers
- Target: 2X the performance, without making the wires "2x faster"

< Power

- 14nm Tri-Gate process (FinFET) provides process benefit for power
- Expanded use of VID and power management adds more
 - High-Performance 800 mV to 940 mV
 - Low-Power options from 850 mV down to 800 mV
- HyperFlex for power reduction
 - Combine performance from HyperFlex with low-power options
- **Target**: 50% to 70% lower power per function, without slowing down

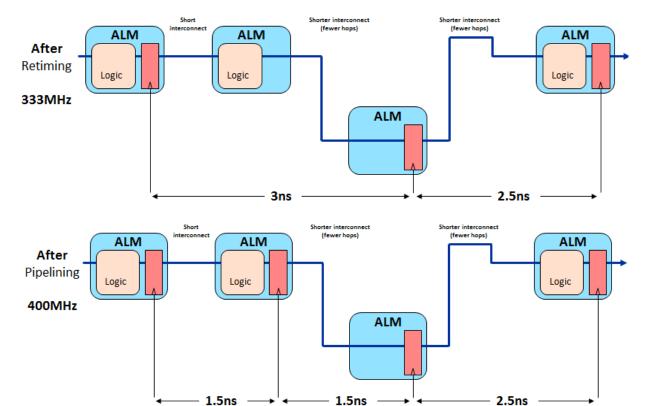


Re-timing and Pipelining in Conventional FPGAs



Raw Logic

- Unbalanced paths



Re-Timing

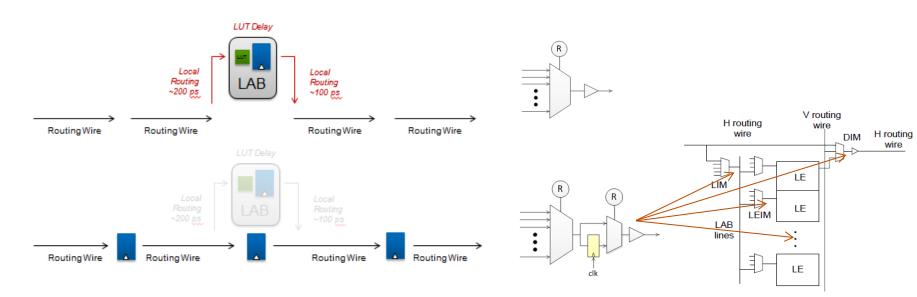
- Balance flops
- 16% f_{max} gain
- Added area

Pipelining

- Add flops
- 40% f_{max} gain
- Added clock tick
- Added area



HyperFlex: Pipeline Registers by Design



Routing muxes (all H/V wires) have optional registers

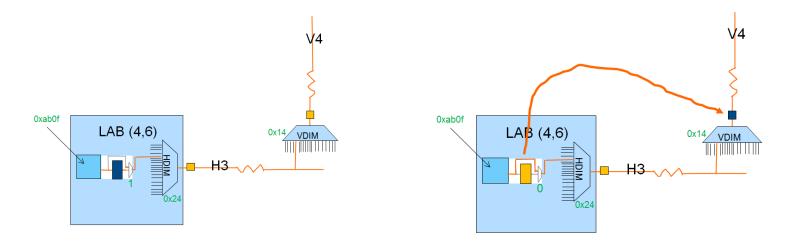
Including LAB, M20K and DSP block inputs, CC, SCLR/CE

Architectural Goals:

- Perfect balance P&R chooses the right register (of many) to turn on
- Simple Software Re-timing is a simple push/pull along the path
- No wasted LEs Designs with high FF:LUT ratios no longer an issue
- No wasted routing Don't have to route to find an available FF

Moving a Register in the HyperFlex fabric

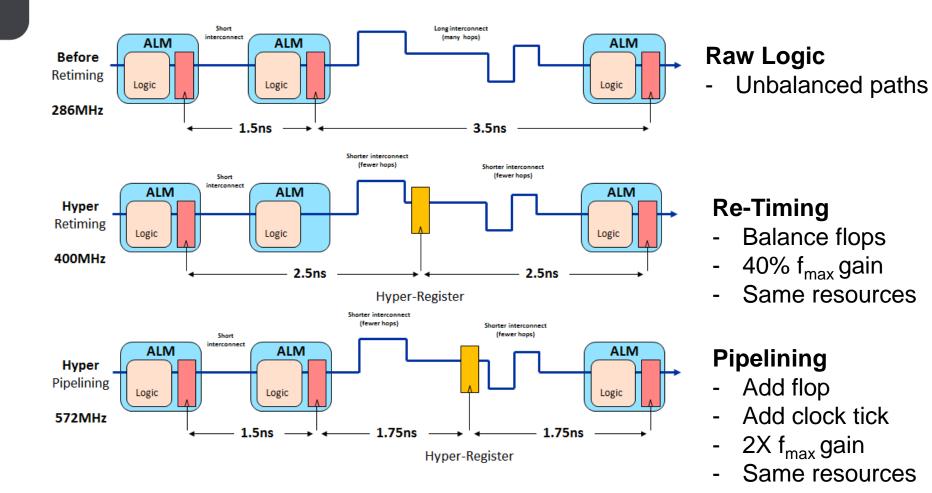
Oisable in ALM, add to routing



Moving a register is a push/pull operation on the route
 There is always a register on the routing mux
 Quartus[®] II chooses the most appropriate FF for path balancing



Re-timing and Pipelining in Stratix 10



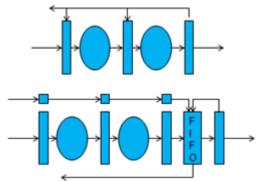
Software and Designer Use-Model

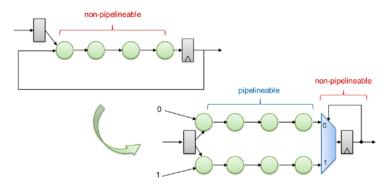
Software adds a new step



Concentrate on critical domains/chains, not volatile reg-reg paths

HyperPipeline the data-path, optimize control logic





Traditional: Similar Criticality

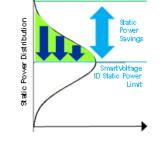
More Critical



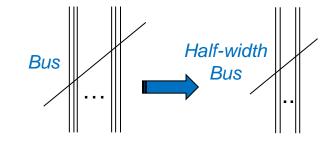
Power: Half the power per function

< 14nm Tri-Gate provides a good chunk of this

- Allows us to take more of the process benefit as performance
- Expanded use of VID and power management
 - M20K and DSP block power gating
- Added registers helps:
 - Reduced footprint for register-heavy designs
- At 2X the speed, reduced size
 - Half the width means half the area
 - Which means half the static power on the same device.

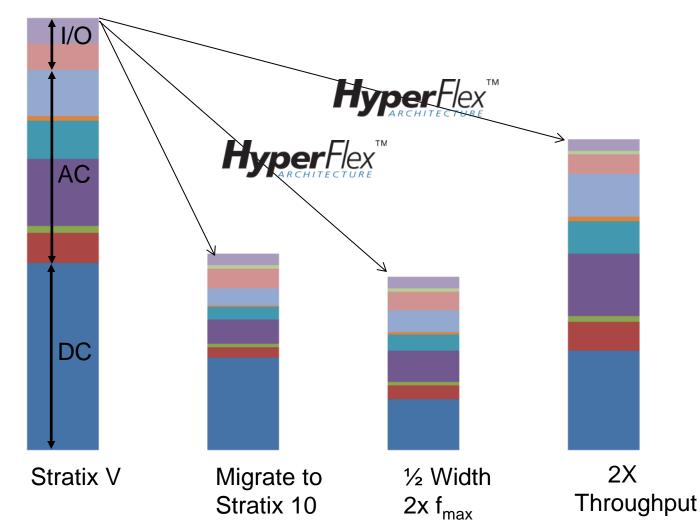


Standard Static Power Limi





Area/Delay/Power Tradeoffs with Stratix 10



Power



Summary

3D integration isn't just integration, it is

- De-risking, process matching, derivative proliferation and tick/tock
- Control Con
 - Software control allows for security and feature-up of devices
- SoC integration is mainstream
 - Processor cost is a small subset of the die, coherent-accelerators
- Pipelining unlocks optimizations in FPGA architecture
 - Using wires efficiently, not brute-forcing them faster
 - Faster == lower power when you can get designs to a more efficient place
- Process is still giving us power benefits
 - 14nm Tri-Gate reduces power, enabling higher performance circuit-design



Thank You

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